

Phrozen Resin User Guide

Engineering Resin: FR940, Gray

Outline

Before printing the perfect object, it is important to first understand the material limitations we are handling and how it can be successfully printed under various conditions. With this in mind, Phrozen provides the following design suggestions to help you better understand the properties of each material and how you can best utilize them to bring your wildest creation to life.

Table of Contents

TDS	1
UL Blue Card Certification	2
Printing	3
Printing Parameters	3
Cleaning	6
Post-Curing	6
Design Specifications	7
Applications	11

Section 1 TDS

General Properties	Norm	Туріса	values
Appearance	-	Gray	
Viscosity, 30	Cone/Plate Rheometer ¹	180–285 mPas	
Density (liquid resin)	ASTM D4052-18a	1.14 g/cm³	
Tensile Properties	Norm	Typical values	
		UV post-cured	UV +Thermal
E Modulus	ASTM D638	1812 MPa	1537 MPa
Ultimate Tensile Strength	ASTM D638	28.5 MPa	38.1 MPa
Elongation at Break	ASTM D638	3.8 % 4.9 %	
Impact Properties	Norm	Typical values	
		UV post-cured	UV +Thermal
Notched Izod (Machined), 23 °C	ASTM D256 30.7 J/m		17.5 J/m
		Typical values	
Thermal Properties	Norm	UV post-cured	UV +Thermal
HDT at 0.45 MPa	ASTM D648	59.8 °C	82.8 °C
Hardness	Norm	Typical values	
		UV post-cured	UV +Thermal
Shore D	ASTM D2240 75-80D		82D
Flammability	Norm	Typical values	
V-0 Burning stops within 10 seconds on a vertical specimen; drips of particles are allowed as long as they are not inflamed.	UL94 V-0	3.0-3.3mm	

*Except for the UL Test, which is printed on the Sonic Mini 4K, all other testing specimens are printed using Phrozen Sonic Mighty 8K or Sonic Mini 8K, and post-cured using Phrozen Cure & Wash. * After 60 minutes of post-curing, heat to 80°C for two more hours.



IEC AC Dielectric Strength (AC DS)

IEC DC Dielectric Strength (DC DS)

IEC Volume Resistivity (VR)

IEC Surface Resistivity (SR)

IEC Ball Pressure

ISO Tensile Strength

ISO Tensile Impact

ISO Charpy Impact

ISO Izod Impact

ISO Flexural Strength

IEC Inclined Plane Tracking (IPT)

ISO Heat Deflection (1.80 MPa)

* Increasing curing time can improve mechanical properties but also increase the risk of deformation.

Specimens are printed unless stated otherwise. The information in this TDS, including product recommendations, is based on our current knowledge and experience. Descriptions, drawings, photographs, data, proportions, weights, etc. provided may change without notice and do not establish the product's contractual quality. Request the relevant MSDS from your supplier or contact Phrozen Tech Co., Ltd at sales@phrozen3d.com



UL Blue Card Certification

q.ul.com	Contract and the						
Plastics for Additive I	Manufacturing						E53542
Guide Information		Vie	w Certificate of Con	npliance			
PHROZEN TEC	H CO LTD hongpu VIg Xiangshan District, Hsin	obu 200050 TV	M.				
	nongpu vig klangsnan District, Hsin	chu 300039 1 v	v				
Phrozen-FR940 (Process Category: V Acrylic, furnished as	AT Polymerization - Liquid Crysta	al Display (LC	D)				
, ,	Min, Thk	Flame			RTI	RTI	RTI
Color	<u>(mm)</u>	Class	HWI	HAI	Elec	Imp	Str
GY	3.0-3.3	V-0	-		50	50	50
Comp	arative Tracking Index (CTI): -		Inclined	Plane Tracking	(IPT) kV: -		
	Dielectric Strength (kV/mm): -		Volume	Resistivity (10x	ohm-cm): -		
High-Voltag	e Arc Tracking Rate (HVTR): -		Surface Resistivity (10 ^x ohms/square): -				
Dimensional Change (%): -			High Volt, Low Current Arc Resis (D495): -				
	Processing Parameters						
	Build Plane: Horizontal & \	/ertical		L	ayer Thickne	ess (mm): 0.(05-0.1
Post Pr	rocessing Method: Please see fo	otnote (#)					
Fo	or use with printer: Phrozen Soni	c Mini 4K					
Limited properties and	ratings assigned to samples produced b Other print paramete		anufacturing technique r tegies may result in sigr			ng parameters a	and build strategy.
object wit	ect in Phrozen Wash with 95% alcohol fo th no exposure to light. Use post-curing o velength to cure for 30 minutes.						
	data does not pertain to building materials, fu erials used in the components and parts of er						ammability of plastic
Report Date: 2023-09-2	11						
Last Revised: 2023-11-0							H
			© 2023 UL Solutions				ALSO CERTIFIED TO EC REQUIREMENTS

IEC and ISO Test Met	thods		- 44			This (see)	
Test Name		Test M		Unit	3	Thk (mm)	Value
Flammability	by (CIWEI)		695-11-10 695-2-12	Class (c °C	olor)	3.0-3.3	V-0 (GY)
Glow-Wire Flammabilit			695-2-12	°C		(124)	Ē.
Glow-Wire Ignition (GV IEC Comparative Trac		IEC 60		Volts (N	(vel		-
EC Comparative frac	Any most	IEC 60	112	VOILS (N	na.k)	33 7 72	

IEC 60243-1

IEC 60243-2

IEC 62631-3-1

IEC 62631-3-2

IEC 60695-10-2

IEC 60587

ISO 75-2

ISO 527-2

ISO 178

ISO 8256

ISO 180

ISO 179-1

kV/mm

kV/mm

10^x ohm-m

10^x ohms

kV

°C

°C

MPa

MPa

kJ/m²

kJ/m²

kJ/m²

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Section 3

Printing

Printing Parameters

Printer	Sonic Mini / Sonic Mini 4K
Layer Height	50 µm
Exposure Time	1.5–2 s
Bottom Exposure Time	30–40 s
Light-off Delay	12 s
Lift Distance	6 mm
Lifting Speed	60 mm/min

Printer	Sonic Mini 8K
Layer Height	50 µm
Exposure Time	2.5–3 s
Bottom Exposure Time	30–40 s
Rest Time After Retract	3 s
Lift Distance	6 mm
Lifting Speed	60 mm/min

Printer	Sonic Mini 8K S
Layer Height	50 µm
Exposure Time	1.5–2 s
Bottom Exposure Time	10–15 s
Rest Time After Retract	3 s
Lift Distance	6 mm
Lifting Speed	60 mm/min



Printer	Sonic Mighty 4K
Layer Height	50 µm
Exposure Time	2.5–3 s
Bottom Exposure Time	30–40 s
Light-off Delay	12 s
Lift Distance	8 mm
Lifting Speed	60 mm/min

Printer	Sonic Mighty 8K
Layer Height	50 µm
Exposure Time	2.5–3 s
Bottom Exposure Time	30–40 s
Rest Time After Retract	3 s
Lift Distance	8 mm
Lifting Speed	60 mm/min

Printer	Sonic Mighty 12K (Upgrade Kit)
Layer Height	50 µm
Exposure Time	2.5–3 s
Bottom Exposure Time	30–40 s
Rest Time After Retract	3 s
Lift Distance	8 mm
Lifting Speed	60 mm/min



Printer	Sonic Mega 8K*
Layer Height	50 µm
Exposure Time	30–40 s
Bottom Exposure Time	2.5–3.5 s
Rest Time After Retract	3 s
Lift Distance	8 mm
Lifting Speed	45 mm/min

Printer	Sonic Mega 8K S
Layer Height	50 µm
Exposure Time	15–20 s
Bottom Exposure Time	1.5–2 s
Rest Time After Retract	3 s
Lift Distance	8 mm
Lifting Speed	60 mm/min

* Mega 8K has a higher peeling force. Therefore, a longer exposure time is necessary to increase the success rate.

* Be sure to cover the hood when printing to maintain the best printing condition of the resin.



Cleaning

- After removing the printed object from the building stage, use the Phrozen Wash and Cure Kit for post-processing.
- Soak the object in Phrozen Washing Station filled with 95% alcohol for 45–60 seconds to remove uncured resin from the surface. Do not soak models for more than 60 seconds in alcohol (or other solvent such as IPA), as it may damage the surfaces.
- 3. Make sure to clean the inner parts of hollow objects completely.
- 4. After the object has been thoroughly cleaned, leave it in a cool, well-ventilated place for at least 30 minutes without exposure to light. Alternatively, you may gently apply compressed air to dry the printed object.

*When printing flat on the building plate, remove the printed objects carefully to avoid deformation on the objects.

Post-Curing

 Use Phrozen post-curing equipment (Phrozen Curing Station/Phrozen Cure/ Phrozen Mega Cure) or other post-curing lamps with the same wavelength to cure printed objects for 30–60 minutes for the best results.

Section 4

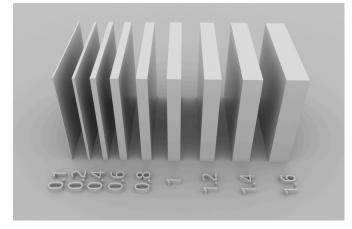
Design Specifications

% Note: All indicators are limited to each resin; the value will vary with different machines and environmental conditions.%

Minimum Unsupported Wall Thickness

This indicator shows the minimum wall thickness that can be printed independently with no support without causing any bending or breaking.

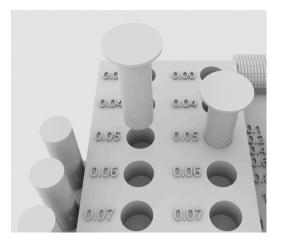
Recommended thickness: ≥ 0.4 mm



Size Tolerance, X-Y plane

This indicator shows the minimum dimensional tolerance between the hole and the column parallel to the XY plane.

Recommended tolerance: ≥ 0.2 mm

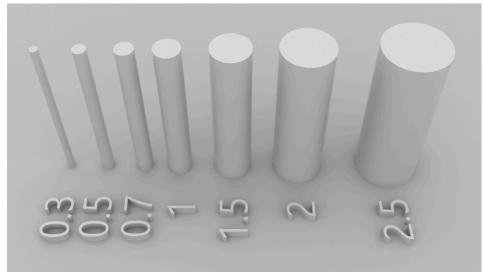




Minimum Pin Diameter

This indicator shows the minimum column diameter of pillars and supports that can be printed independently without bending or breaking.

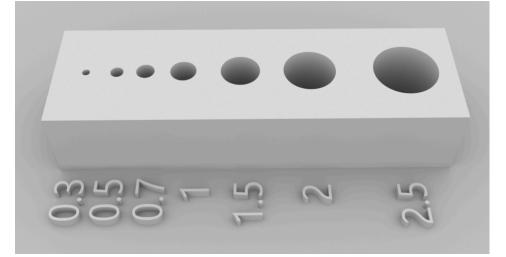
Recommended diameter: ≥ 0.7 mm



Minimum Hole Diameter, X-Y plane

This indicator shows the minimum hole diameter that can be successfully printed parallel to the XY plane.

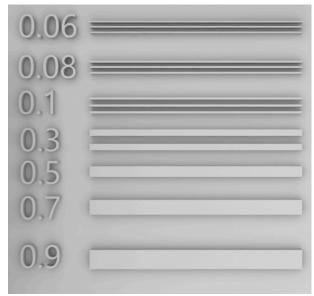
Recommended diameter: ≥ 1 mm





Minimum Embossed Detail Width, X-Y plane

This indicator shows the minimum line width that can successfully be printed with embossed details.

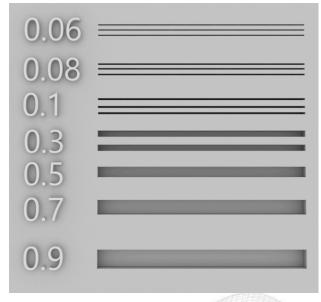


Recommended width: ≥ 0.1 mm

Minimum Engraved Detail Width, X-Y plane

This indicator shows the minimum line width that can successfully be printed with engraved details.

Recommended width: ≥ 0.5 mm

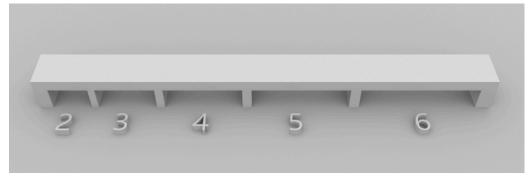




Maximum Horizontal Bridge Span

This indicator shows the maximum width between the supporting walls that can be printed without deforming the bridge.

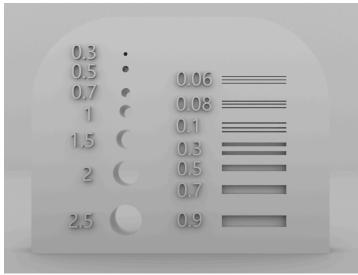
Recommended width: ≤ 6 mm



Minimum Hole Diameter and Engraved Detail Width, Z-Axis, at 0.05mm Layer Height

This indicator shows the minimum hole diameter and engraving groove width that can be successfully printed on the Z-axis with a layer thickness of 0.05mm.

Recommended diameter. ≥ 0.7 mm Recommended width: ≥ 0.3 mm





Section 5

Applications

